

MOS FIELD EFFECT TRANSISTOR

2SK2141

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2141 is N-channel Power MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

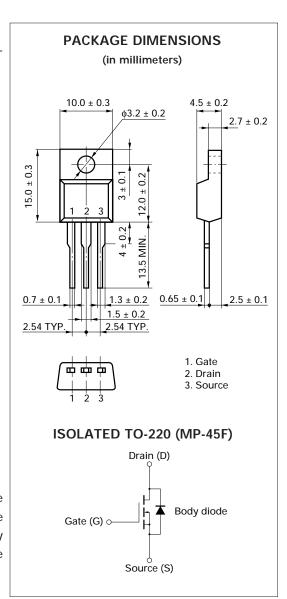
- Low On-state Resistance $R_{DS(on)} = 1.1 \Omega MAX. (V_{GS} = 10 V, I_{D} = 3.0 A)$
- Low Ciss Ciss = 1150 pF TYP.
- High Avalanche Capability Ratings
- Isolated TO-220 (MP-45F) Package

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C)

Drain to Source Voltage	V_{DSS}	600	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	ID (DC)	±6.0	Α
Drain Current (pulse)	ID (pulse)*	±24	Α
Total Power Dissipation (Tc = 25 °C)	P _{T1}	35	W
Total Power Dissipation (Ta = 25 °C)	P _{T2}	2.0	W
Storage Temperature	Tstg -55	to +150	°C
Channel Temperature	Tch	150	°C
Single Avalanche Current	las**	6.0	Α
Single Avalanche Energy	Eas**	12	mJ

^{*}PW \leq 10 μ s, Duty Cycle \leq 1%

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.



^{**}Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0

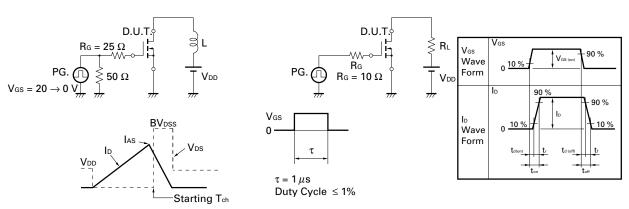


E主气TRICALL"(中内下)CTERISTICS (TA = 25 °C)

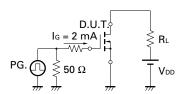
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CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	R _{DS(on)}		0.8	1.1	Ω	Vgs = 10 V, ID = 3.0 A
Gate to Source Cutoff Voltage	V _{GS(off)}	2.5		3.5	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	yfs	2.0			S	V _{DS} = 10 V, I _D = 3.0 A
Drain Leakage Current	IDSS			100	μΑ	V _{DS} = 600V, V _{GS} = 0
Gate to Source Leakage Current	Igss			±100	nA	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Input Capacitance	Ciss		1150		pF	V _{DS} = 10 V
Output Capacitance	Coss		260		pF	Vgs = 0
Reverse Transfer Capacitance	Crss		60		pF	f = 1 MHz
Turn-On Delay Time	td(on)		15		ns	Vgs = 10 V
Rise Time	tr		15		ns	V _{DD} = 150 V
Turn-Off Delay Time	td(off)		75		ns	$I_D = 3.0 \text{ A, Rg} = 10 \Omega$
Fall Time	t f		13		ns	R _L = 37.5 Ω
Total Gate Charge	Q _G		40		nC	Vgs = 10 V
Gate to Source Charge	Qgs		6.0		nC	ID = 6.0 A
Gate to Drain Charge	Q _{GD}		20		nC	VDD = 480 V
Diode Forward Voltage	V _{F(S-D)}		1.0		V	IF = 6.0 A, VGS = 0
Reverse Recovery Time	trr		370		ns	IF = 6.0 A
Reverse Recovery Charge	Qrr		1.5		μC	di/dt = 50 A/μs

Test Circuit 1: Avalanche Capability

Test Circuit 2: Switching Time



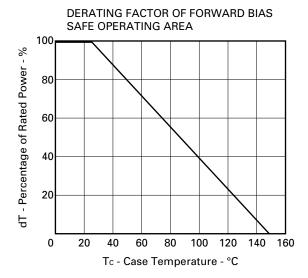
Test Circuit 3: Gate Charge



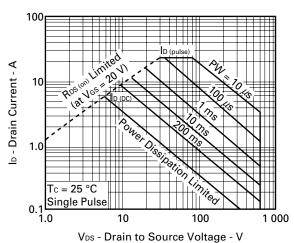
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.



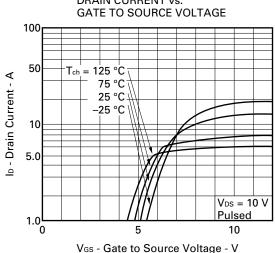
查询"KYPICA供应商RACTERISTICS (TA = 25 °C)

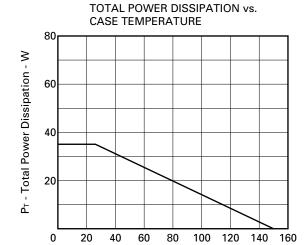


FORWARD BIAS SAFE OPERATING AREA



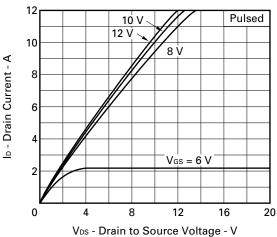
DRAIN CURRENT vs.



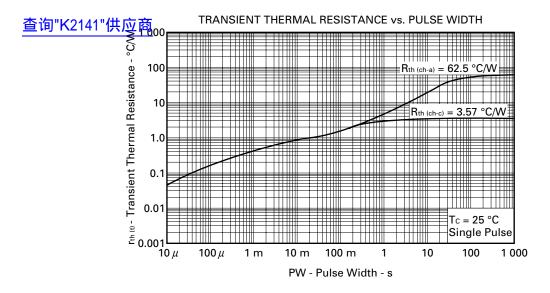


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

Tc - Case Temperature - °C

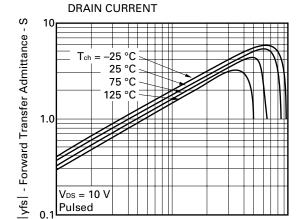






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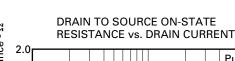
C



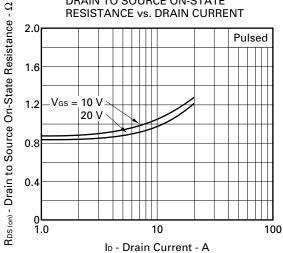
1.0

ID - Drain Current - A

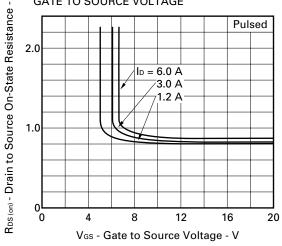
FORWARD TRANSFER ADMITTANCE vs.



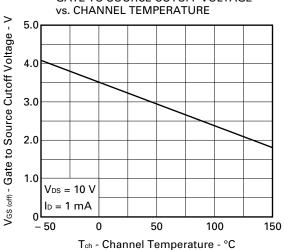
0.1 0.1



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

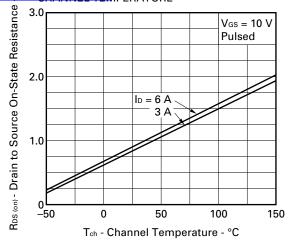


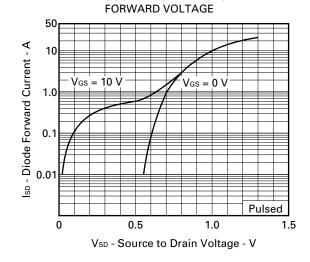
GATE TO SOURCE CUTOFF VOLTAGE



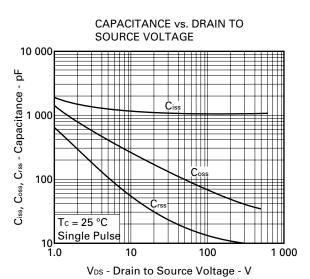
NEC

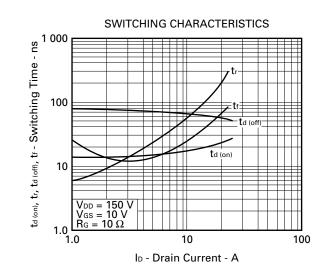
查询。K2 DRAINTO SOURCE ON STATE RESISTANCE vs.

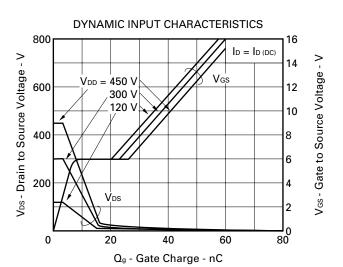


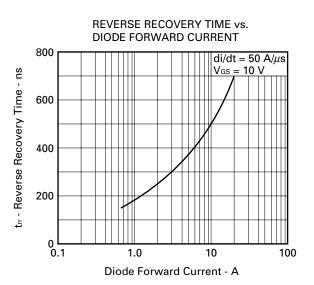


SOURCE TO DRAIN DIODE



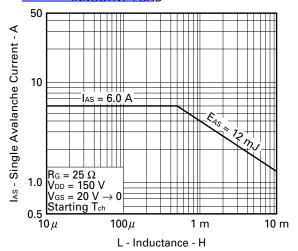




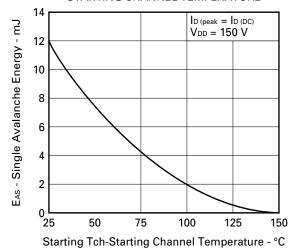




查询"K SINGLEA WALLANCHE CURRENT vs.



SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE





查询"REFERENÇE商

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

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Anti-radioactive design is not implemented in this product.

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